
**Information technology — UPnP
Device Architecture —**

**Part 30-2:
IoT management and control device
control protocol — IoT management
and control device**

Technologies de l'information — Architecture de dispositif UPnP —

*Partie 30-2: Protocole de contrôle de dispositif de gestion et de
contrôle de l'Internet des objets — Dispositif de gestion et de contrôle
de l'Internet des objets*



Reference number
ISO/IEC 29341-30-2:2017(E)

AVA Documents
Document Sharing Hub
© ISO/IEC 2017



COPYRIGHT PROTECTED DOCUMENT

© ISO/IEC 2017, Published in Switzerland

All rights reserved. Unless otherwise specified, no part of this publication may be reproduced or utilized otherwise in any form or by any means, electronic or mechanical, including photocopying, or posting on the internet or an intranet, without prior written permission. Permission can be requested from either ISO at the address below or ISO's member body in the country of the requester.

ISO copyright office
Ch. de Blandonnet 8 • CP 401
CH-1214 Vernier, Geneva, Switzerland
Tel. +41 22 749 01 11
Fax +41 22 749 09 47
copyright@iso.org
www.iso.org

CONTENTS

1	Scope.....	1
2	Normative References	1
3	Terms, Definitions and Abbreviations	2
4	Notations and conventions	2
4.1	Notation	2
4.2	Data Types	2
4.3	Vendor-defined Extensions	3
5	Device Definitions	3
5.1	Device Type	3
5.2	Device Model.....	3
5.2.1	Description of Device Requirements	4
5.2.2	Relationships Between Services	4
6	XML Device Description.....	4
Annex A	- Theory of Operation (informative)	6
A.1	Introduction	6
A.2	Device Discovery	6
A.3	Sensor Discovery, Configuration and Status Reading	6
A.4	Reading and Writing of Data	6
A.5	Connecting Sensors to Transport Clients.....	7
Figure 1	— IOT Management and Control Device Functional Diagram.....	1
Figure A.1	—Simple Read and Write Flow Diagram.	7
Figure A.2	— Connecting a IoT Management and Control Device to an External Storage.	8
Table 1	— Device Requirements	3

Foreword

ISO (the International Organization for Standardization) and IEC (the International Electrotechnical Commission) form the specialized system for worldwide standardization. National bodies that are members of ISO or IEC participate in the development of International Standards through technical committees established by the respective organization to deal with particular fields of technical activity. ISO and IEC technical committees collaborate in fields of mutual interest. Other international organizations, governmental and non-governmental, in liaison with ISO and IEC, also take part in the work. In the field of information technology, ISO and IEC have established a joint technical committee, ISO/IEC JTC 1.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of document should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see <http://www.iso.org/directives>).

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. ISO and IEC shall not be held responsible for identifying any or all such patent rights. Details of any patent rights identified during the development of the document will be in the Introduction and/or on the ISO list of patent declarations received (see www.iso.org/patents).

Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the voluntary nature of Standards, the meaning of the ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the WTO principles in the Technical Barriers to Trade (TBT) see the following URL: [Foreword – Supplementary information](#).

ISO/IEC 29341-30-2 was prepared by UPnP Forum and adopted, under the PAS procedure, by joint technical committee ISO/IEC JTC 1, *Information technology*, in parallel with its approval by national bodies of ISO and IEC.

The list of all currently available parts of ISO/IEC 29341 series, under the general title *Information technology — UPnP Device Architecture*, can be found on the [ISO web site](#).

Introduction

ISO and IEC draw attention to the fact that it is claimed that compliance with this document may involve the use of patents as indicated below.

ISO and IEC take no position concerning the evidence, validity and scope of these patent rights. The holders of -these patent rights have assured ISO and IEC that they are willing to negotiate licenses under reasonable and non-discriminatory terms and conditions with applicants throughout the world. In this respect, the statements of the holders of these patent rights are registered with ISO and IEC.

Intel Corporation has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Intel Corporation
Standards Licensing Department
5200 NE Elam Young Parkway
MS: JFS-98
USA – Hillsboro, Oregon 97124

Microsoft Corporation has informed IEC and ISO that it has patent applications or granted patents as listed below:

6101499 / US; 6687755 / US; 6910068 / US; 7130895 / US; 6725281 / US; 7089307 / US;
7069312 / US; 10/783 524 /US

Information may be obtained from:

Microsoft Corporation
One Microsoft Way
USA – Redmond WA 98052

Philips International B.V. has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Philips International B.V. – IP&S
High Tech campus, building 44 3A21
NL – 5656 Eindhoven

NXP B.V. (NL) has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

NXP B.V. (NL)
High Tech campus 60
NL – 5656 AG Eindhoven

Matsushita Electric Industrial Co. Ltd. has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Matsushita Electric Industrial Co. Ltd.
1-3-7 Shiromi, Chuoh-ku
JP – Osaka 540-6139

Hewlett Packard Company has informed IEC and ISO that it has patent applications or granted patents as listed below:

5 956 487 / US; 6 170 007 / US; 6 139 177 / US; 6 529 936 / US; 6 470 339 / US; 6 571 388 /
US; 6 205 466 / US

ISO/IEC 29341-30-2:2017(E)

Information may be obtained from:

Hewlett Packard Company
1501 Page Mill Road
USA – Palo Alto, CA 94304

Samsung Electronics Co. Ltd. has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Digital Media Business, Samsung Electronics Co. Ltd.
416 Maetan-3 Dong, Yeongtang-Gu,
KR – Suwon City 443-742

Huawei Technologies Co., Ltd. has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Huawei Technologies Co., Ltd.
Administration Building, Bantian Longgang District
Shenzhen – China 518129

Qualcomm Incorporated has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Qualcomm Incorporated
5775 Morehouse Drive
San Diego, CA – USA 92121

Telecom Italia S.p.A. has informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Telecom Italia S.p.A.
Via Reiss Romoli, 274
Turin - Italy 10148

Cisco Systems informed IEC and ISO that it has patent applications or granted patents.

Information may be obtained from:

Cisco Systems, Inc.
170 West Tasman Drive
San Jose, CA – USA 95134

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights other than those identified above. ISO and IEC shall not be held responsible for identifying any or all such patent rights.